

DSC61XX

Ultra-Small, Ultra-Low Power MEMS Oscillator

Features

- Wide Frequency Range: 2 kHz to 100 MHz
- Ultra-Low Power Consumption: 3 mA/12 µA (Active/Standby)
- Ultra-Small Footprints
 - 1.6 mm imes 1.2 mm
 - 2.0 mm \times 1.6 mm
 - 2.5 mm imes 2.0 mm
 - 3.2 mm × 2.5 mm
- Frequency Select Input Supports Two Pre-Defined Frequencies
- High Stability: ±25 ppm, ±50 ppm
- Wide Temperature Range
 - Industrial: -40°C to 85°C
 - Ext. Commercial: -20° to 70°C
- Excellent Shock and Vibration Immunity
 - Qualified to MIL-STD-883
- High Reliability
 - 20x Better MTF Than Quartz Oscillators
- Supply Range of 1.71V to 3.63V
- Short Sample Lead Time: <2 weeks
- Lead Free & RoHS Compliant

Applications

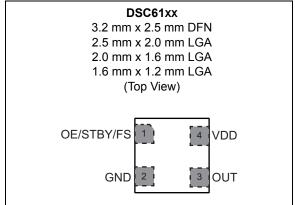
- Low Power/Portable Applications: IoT, Embedded/Smart Devices
- Consumer: Home Healthcare, Fitness Devices, Home Automation
- Automotive: Rear View/Surround View Cameras, Infotainment System
- Industrial: Building/Factory Automation, Surveillance Camera

General Description

The DSC61xx family of MEMS oscillators combines the industry leading low power consumption and ultra-small packages with exceptional frequency stability and jitter performance over temperature. The single-output DSC61xx MEMS oscillators are excellent choices for use as clock references in small, battery-powered devices such as wearable and Internet of Things (IoT) devices in which small size, low power consumption, and long-term reliability are paramount. They also meet the stringent mechanical durability and reliability requirements within Automotive Electronics Council standard Q100 (AEC-Q100), so they are well suited for under-hood applications as well.

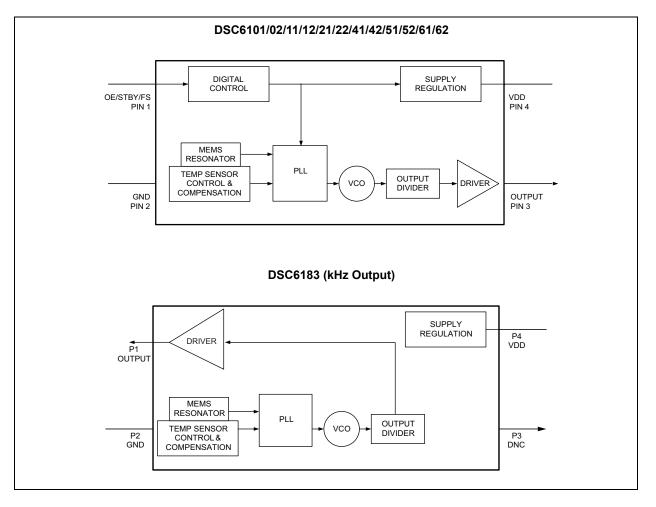
The DSC61xx family is available in ultra-small 1.6 mm x 1.2 mm and 2.0 mm x 1.6 mm packages. Other package sizes include: 2.5 mm x 2.0 mm and 3.2 mm x 2.5 mm. These packages are "drop-in" replacements for standard 4-pin CMOS quartz crystal oscillators.

Package Types



DSC61XX

Block Diagram



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings

Supply Voltage	
Input Voltage (V _{IN})	
ESD Protection	

ELECTRICAL CHARACTERISTICS

Electrical Characteristics	Unless othe	erwise indica	ated, V _{DI}	₀ = 1.8V –5% to	o 3.3V +1	0%, T _A = −40°C to 85°C.
Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
Supply Voltage, Note 1	V _{DD}	1.71	_	3.63	V	—
Power Supply Ramp	t _{PU}	0.1		100	ms	Note 8
Active Supply Current	I _{DD}	_	3.0	—	mA	F _{OUT} = 27 MHz, V _{DD} = 1.8V, No Load
Standby Supply Current	lorny (_	12	—		V _{DD} = 1.8/2.5V
Note 2	I _{STBY}		80	—	μA	V _{DD} = 3.3V
Frequency Stability Note 3	Δf	_		±25 ±50	ppm	All temp ranges
Aging	٨f			±5	222	1st year @ 25°C
Aging	Δf	_	_	±1	ppm	Per year after first year
Startup Time	t _{SU}	_	_	1.3	ms	From 90% V _{DD} to valid clock output, T = 25°C
	V _{IH}	$0.7 \times V_{DD}$	_	—	V	Input Logic High
Input Logic Levels Note 4	V _{IL}	_		0.3 x V _{DD}	V	Input Logic Low
Output Disable Time Note 5	t _{DA}	_	_	200+Period	ns	—
Output Enable Time Note 6	t _{EN}	_	_	1	μs	_
Enable Pull-up Resistor Note 7	_	_	300	_	kΩ	If configured
	N					Output Logic High, I = 3 mA, Std. Drive
	V _{OH}	0.8 x V _{DD}	_	_	V	Output Logic High, I = 6 mA, High Drive
Output Logic Levels	V			0.2 × 1/	M	Output Logic Low, I = –3 mA, Std. Drive
	V _{OL}			0.2 x V _{DD}	V	Output Logic Low, I = -3 mA, High Drive

Note 1: Pin 4 V_{DD} should be filtered with 0.1 μ F capacitor.

- 2: Not including current through pull-up resistor on EN pin (if configured). Higher standby current seen at >3.3V V_{DD} .
- **3:** Includes frequency variations due to initial tolerance, temp. and power supply voltage.
- 4: Input waveform must be monotonic with rise/fall time < 10 ms
- 5: Output Disable time takes up to one period of the output waveform + 200 ns.
- 6: For parts configured with OE, not Standby.
- 7: Output is enabled if pad is floated or not connected.
- 8: Time to reach 90% of target V_{DD}. Power ramp rise must be monotonic.

ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical Characteristics	: Unless othe	erwise indica	ated, V _{DD}	₀ = 1.8V –5% te	o 3.3V +1	0%, T _A = -40°	C to 85°C.
Parameters	Sym.	Min.	Тур.	Max.	Units	Со	nditions
	L /L	_	1	1.5	ns	DSC61x2 High Drive,	V _{DD} = 1.8V
Output Transition Time	t _{RX} /t _{FX}	_	0.5	1.0	ns	20% to 80% C _L = 15 pF	V _{DD} = 2.5V/3.3V
Rise Time/Fall Time	1 <i>1</i> 1		1.2	2.0	ns	DSC61x1 Std Drive,	V _{DD} = 1.8V
	t _{RY} /t _{FY}	_	1.5	2.2	ns	20% to 80% C _L = 10 pF	V _{DD} = 2.5V/3.3V
Frequency	f ₀	0.002	_	100	MHz	Output on F	Pin 1 for < 1 MHz
Output Duty Cycle	SYM	45	_	55	%		_
Dariad litter DMO	1	_	9.5	11		F _{OUT} =	V _{DD} = 1.8V
Period Jitter, RMS	J _{PER}	_	7.5	9	ps _{RMS}	27 MHz	V _{DD} = 2.5V/3.3V
Cycle-to-Cycle Jitter		_	50	70		F _{OUT} =	V _{DD} = 1.8V
(peak)	J _{Cy–Cy}	_	35	60	ps	27 MHz	V _{DD} = 2.5V/3.3V

Note 1: Pin 4 V_{DD} should be filtered with 0.1 μF capacitor.

2: Not including current through pull-up resistor on EN pin (if configured). Higher standby current seen at >3.3V V_{DD} .

3: Includes frequency variations due to initial tolerance, temp. and power supply voltage.

4: Input waveform must be monotonic with rise/fall time < 10 ms

5: Output Disable time takes up to one period of the output waveform + 200 ns.

6: For parts configured with OE, not Standby.

7: Output is enabled if pad is floated or not connected.

8: Time to reach 90% of target V_{DD} . Power ramp rise must be monotonic.

TEMPERATURE SPECIFICATIONS (Note 1)

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
Temperature Ranges						
Junction Operating Temperature	TJ	_	_	+150	°C	—
Ambient Operating Temperature	T _A	-40	_	+85	°C	Industrial
Ambient Operating Temperature	T _A	-20	—	+70	°C	Extended Commercial
Storage Ambient Temperature Range	T _A	-55	—	+150	°C	—
Soldering Temperature	Τ _S		+260	_	°C	40 sec. max.

Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T_A, T_J, θ_{JA}). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +150°C rating. Sustained junction temperatures above +150°C can impact the device reliability.

2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1 and Table 2-2.

TABLE 2-1: DSC6101/02/11/12/21/22/41/42/51/52/61/62 PIN FUNCTION TABLE (OUTPUT FREQUENCY ≥1 MHZ)

Pin Number	Pin Name	Pin Type	Description
	OE		Output Enable: H = Specified Frequency Output, Note 1 L = Output is high impedance
1	STBY	I	Standby: H = Specified Frequency Output, Note 1 L = Output is high impedance. Device is in low power mode, supply current is at I _{STBY}
	FS		Frequency Select: H = Output Frequency 1, Note 2 L = Output Frequency 2
2	GND	Power	Power supply ground
3	Output	0	Oscillator clock output
4	VDD	Power	Power supply

Note 1: DSC610x/1x/2x has 300 kΩ internal pull-up resistor on pin1. DSC614x/5x/6x has no internal pull-up resistor on pin1 and needs external pull-up or being driven by other chip.

- 2: Two pre-programmed frequencies can be configured at http://clockworks.microchip.com/timing/
- 3: Bypass with 0.1 μ F capacitor placed as close to V_{DD} pin as possible.

TABLE 2-2: DSC6183 PIN FUNCTION TABLE (OUTPUT FREQUENCY <1 MHZ)

Pin Number	Pin Name	Pin Type	Description
1	Output	0	Kilohertz Oscillator clock output
2	GND	Power	Power supply ground
3	DNC	DNC	Do Not Connect
4	VDD	Power	Power supply, Note 1

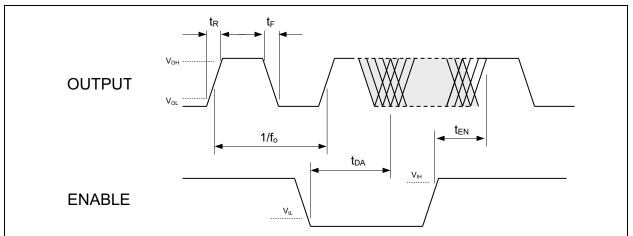
Note 1: Bypass with 0.1 μ F capacitor placed as close to V_{DD} pin as possible.

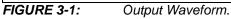
2.1 Output Buffer Options

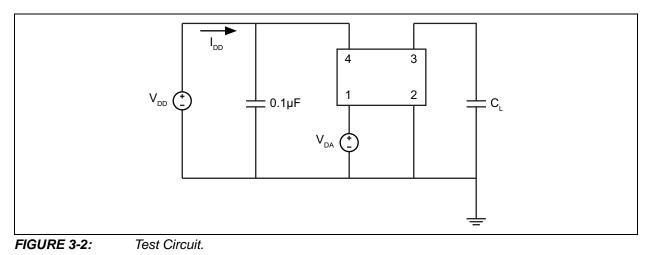
DSC61xx family is available in multiple output driver configurations.

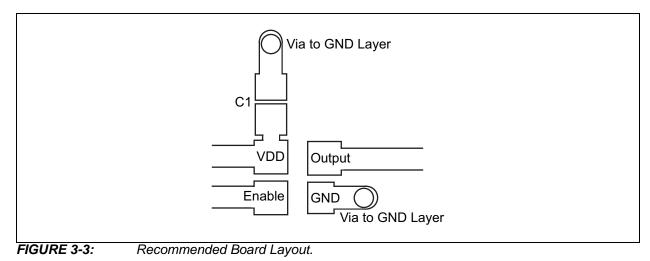
The standard-drive (61x1) and high-drive (61x2) deliver respective output currents of greater than 3 mA and 6 mA at 20%/80% of the supply voltage. For heavy loads of 15 pF or higher, the high-drive option is recommended.

3.0 DIAGRAMS

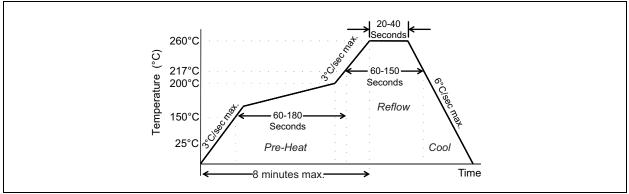


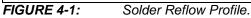






4.0 SOLDER REFLOW PROFILE

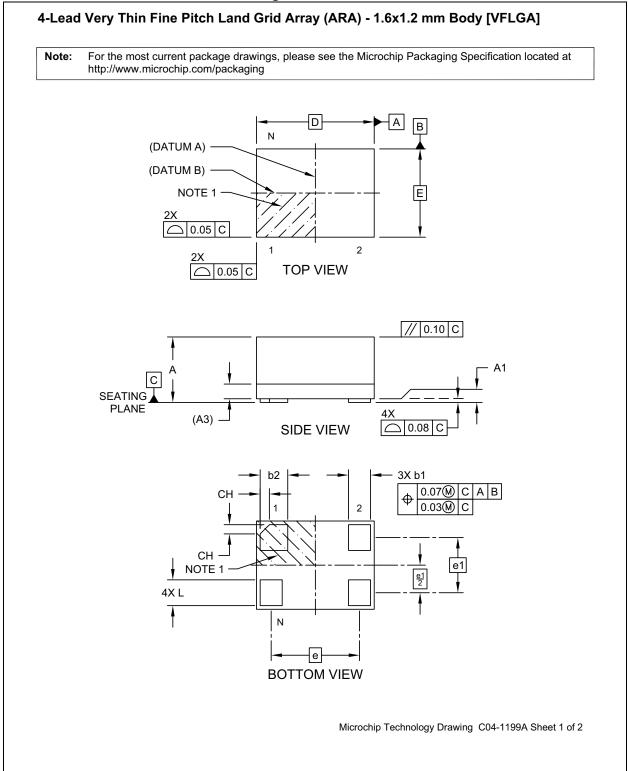




MSL 1 @ 260°C refer to JS	TD-020C
Ramp-Up Rate (200°C to Peak Temp)	3°C/sec. max.
Preheat Time 150°C to 200°C	60 to 180 sec.
Time maintained above 217°C	60 to 150 sec.
Peak Temperature	255°C to 260°C
Time within 5°C of actual Peak	20 to 40 sec.
Ramp-Down Rate	6°C/sec. max.
Time 25°C to Peak Temperature	8 minutes max.

5.0 PACKAGING INFORMATION

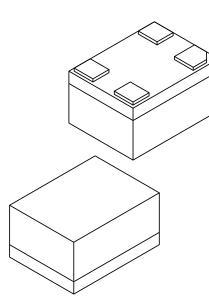
4-Lead VFLGA 1.6 mm x 1.2 mm Package Outline



4-Lead VFLGA 1.6 mm x 1.2 mm Package Outline

4-Lead Very Thin Fine Pitch Land Grid Array (ARA) - 1.6x1.2 mm Body [VFLGA]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	N	IILLIMETER	S
Dimension	Limits	MIN	NOM	MAX
Number of Terminals	N		4	
Terminal Pitch	е		1.20 BSC	
Terminal Pitch	e1		0.75 BSC	
Overall Height	Α	0.79	0.84	0.89
Standoff	A1	0.00	0.02	0.05
Substrate Thickness (with Terminals)	A3		0.20 REF	
Overall Length	D		1.60 BSC	
Overall Width	Е		1.20 BSC	
Terminal Width	b1	0.25	0.30	0.35
Terminal Width	b2	0.325	0.375	0.425
Terminal Length	L	0.30	0.35	0.40
Terminal 1 Index Chamfer	СН	-	0.125	-

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

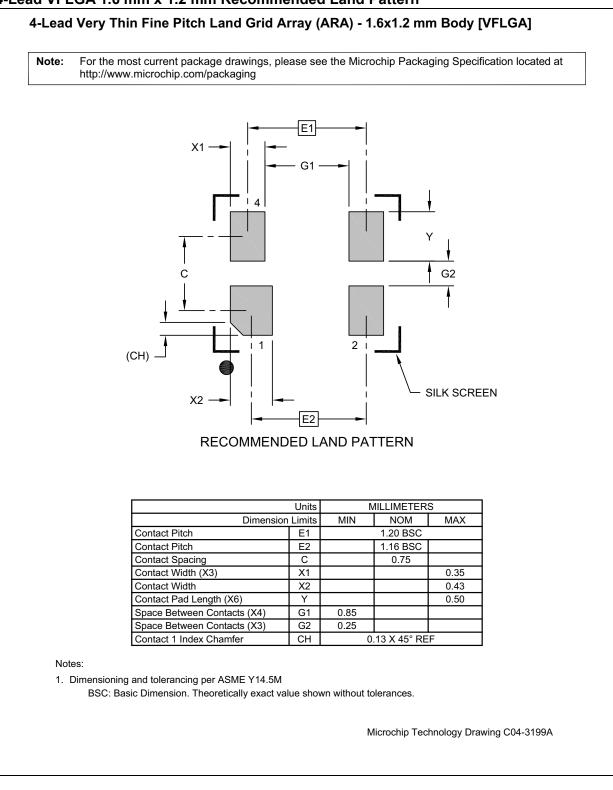
2. Package is saw singulated

3. Dimensioning and tolerancing per ASME Y14.5M

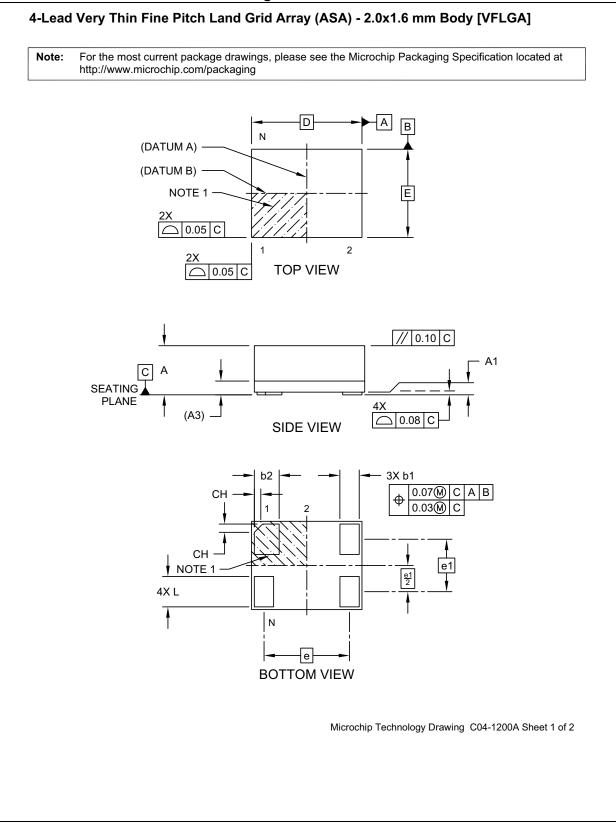
BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-1199A Sheet 2 of 2

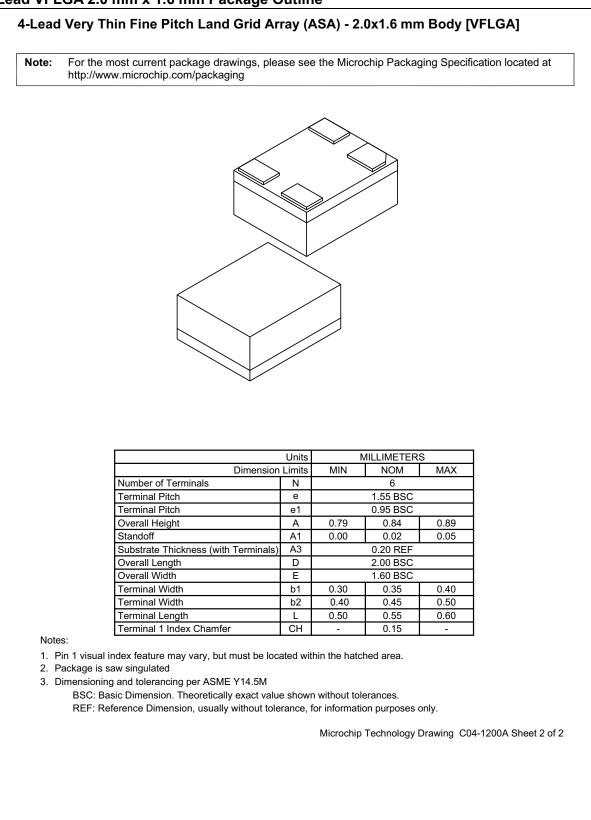
4-Lead VFLGA 1.6 mm x 1.2 mm Recommended Land Pattern



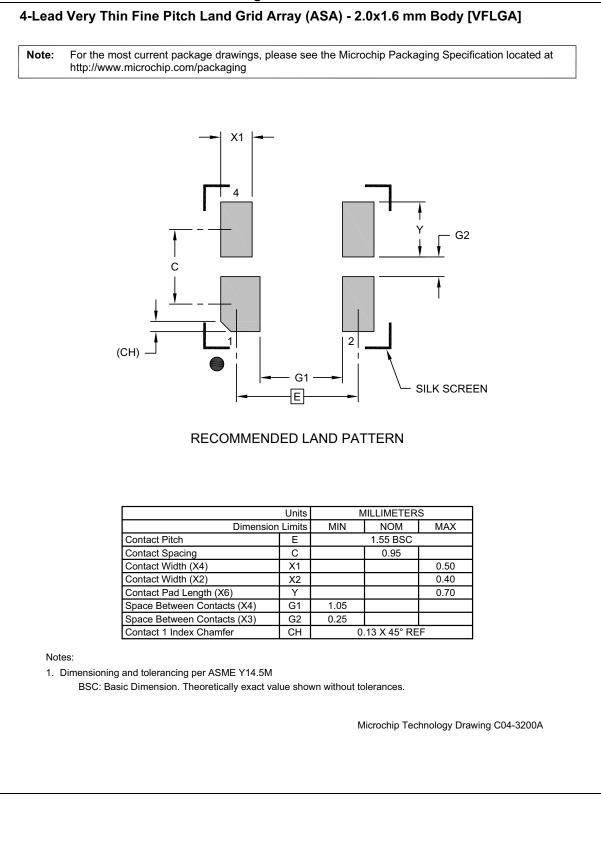
4-Lead VFLGA 2.0 mm x 1.6 mm Package Outline



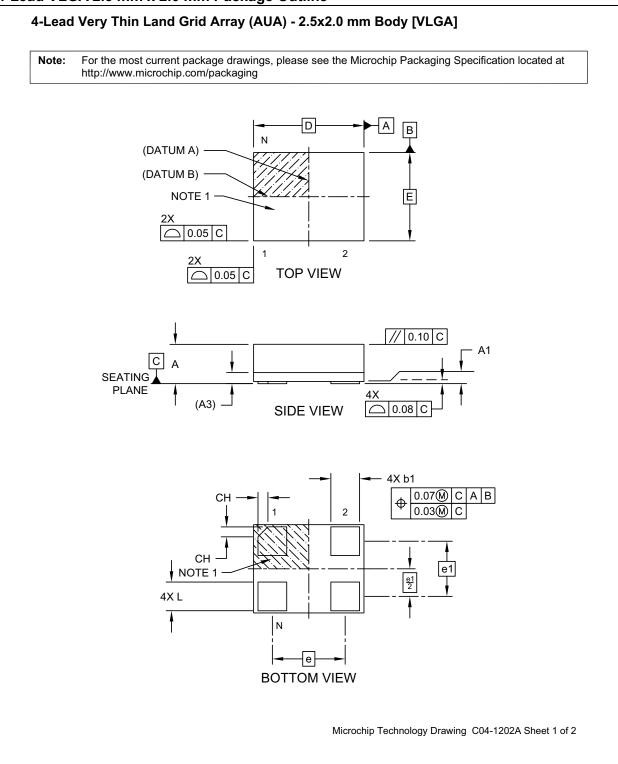
4-Lead VFLGA 2.0 mm x 1.6 mm Package Outline



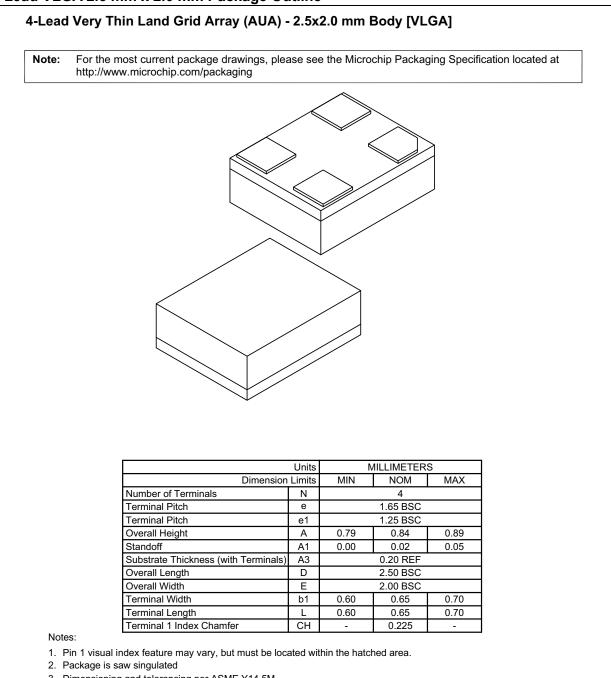
4-Lead VFLGA 2.0 mm x 1.6 mm Package Outline



4-Lead VLGA 2.5 mm x 2.0 mm Package Outline



4-Lead VLGA 2.5 mm x 2.0 mm Package Outline

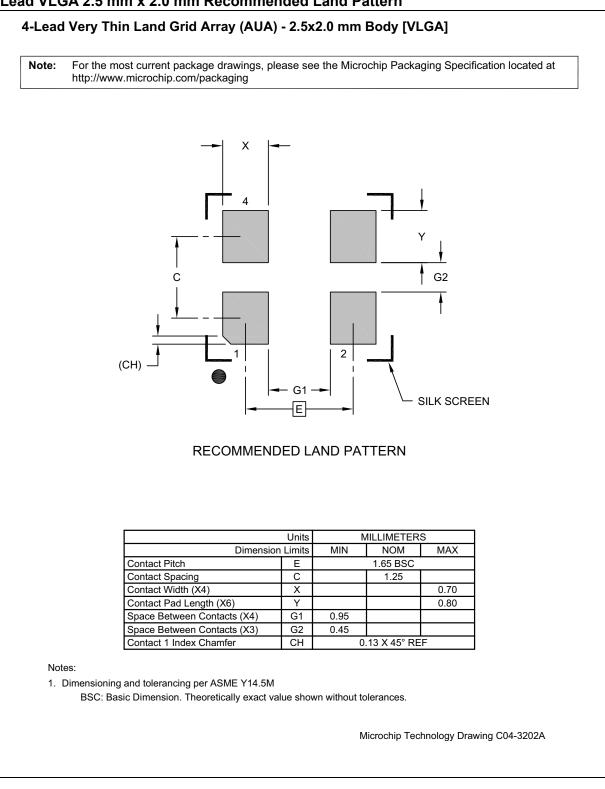


 Dimensioning and tolerancing per ASME Y14.5M BSC: Basic Dimension. Theoretically exact value shown without tolerances.

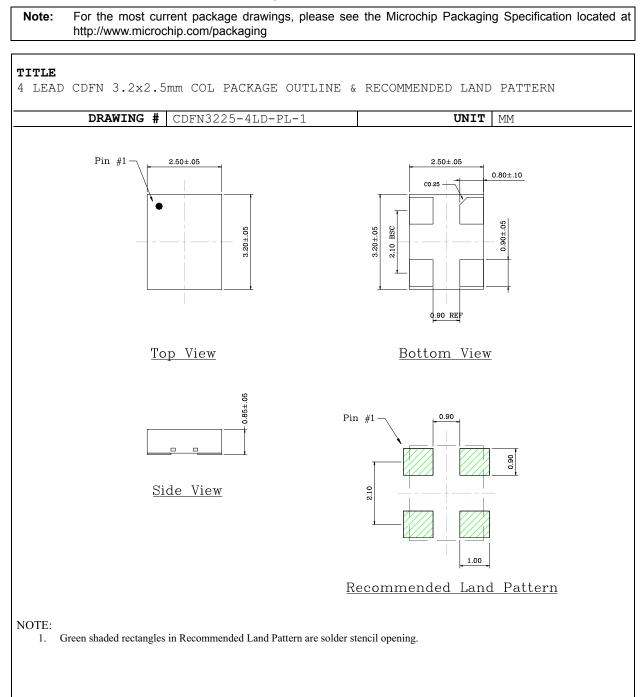
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-1202A Sheet 2 of 2

4-Lead VLGA 2.5 mm x 2.0 mm Recommended Land Pattern



4-Lead CDFN 3.2 mm x 2.5 mm Package Outline and Recommended Land Pattern



APPENDIX A: REVISION HISTORY

Revision A (September 2016)

Initial release of DSC61xx Microchip data sheet DS20005624A.

Revision B (September 2017)

- Added Power Supply Ramp value in Electrical Characteristics table.
- Redrew diagrams for clarity. No technical content affected.

DSC61XX

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

X Package GC61xx: election	Range Ultra-Low Pin 1 OE STBY FS OE STBY FS KHz Output Standard High 4-Lead 3.2 4-Lead 2.5 4-Lead 2.0	X X - XXX.X Frequency Revision Frequency Stability w Power MEMS Oscillator Internal Pull-Up Register Pull-up Pull-up Pull-up None	XX X Inncy Tape and Reel	Ultra- with li 2.5 m ±25 p 100/B b) DSC61 Ultra- Intern 1.6 m Temp Frequ c) DSC61 Ultra- with li 2.0 m ±25 p	 I12JI2A-100.0000: -Low Power MEMS Oscillator, Pin1 = Standby internal Pull-Up, High Drive Strength, 4-Lead im x 2.0 mm VLGA, Industrial Temperature, up Stability, Revision A, 100 MHz Frequency, Bag I01HE1A-016.0000T: -Low Power MEMS Oscillator, Pin1 = OE with the Pull-Up, Standard Drive Strength, 4-Lead im x 1.2 mm VFLGA, Extended Commercial, ±50 ppm Stability, Revision A, 16 MHz uency, 1,000/Reel I21MI2A-005Q: -Low Power MEMS Oscillator, Pin1 = Freq. Select internal Pull-Up, Standard Drive Strength, 4-Lead im x 1.6 mm VFLGA, Industrial Temperature, up Stability, Revision A, Two Frequencies gured through ClockWorks, 100/Bag Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.
=	OE STBY FS OE STBY FS kHz Output Standard High 4-Lead 3.2 4-Lead 2.5 4-Lead 2.0	Pull-up Pull-up Pull-up None None None None Semm x 2.5 mm DFN 5 mm x 2.5 mm VLGA		b) DSC61 Ultra- Intern 1.6 m Temp Frequ C) DSC61 Ultra- with li 2.0 m ±25 p Config	I01HE1A-016.0000T: -Low Power MEMS Oscillator, Pin1 = OE with Ial Pull–Up, Standard Drive Strength, 4-Lead Im x 1.2 mm VFLGA, Extended Commercial ., ±50 ppm Stability, Revision A, 16 MHz Iency, 1,000/Reel I21MI2A-005Q: -Low Power MEMS Oscillator, Pin1 = Freq. Selec Internal Pull-Up, Standard Drive Strength, 4-Lead Im x 1.6 mm VFLGA, Industrial Temperature, Im Stability, Revision A, Two Frequencies gured through ClockWorks, 100/Bag Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package
=	High 4-Lead 3.2 4-Lead 2.5 4-Lead 2.0	5 mm x 2.0 mm VLGA) mm x 1.6 mm VFLGA		Note 1:	catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package
=	4-Lead 2.5 4-Lead 2.0	5 mm x 2.0 mm VLGA) mm x 1.6 mm VFLGA			with your Microchip Sales Office for package
=	4-Leau 1.0	S mm x 1.2 mm VFLGA			
= =		-70°C (Extended Commercia +85°C (Industrial))		
= =	± 50 ppm ± 25 ppm				
=	Revision A	۱.			
xkxxx =	001.0000 l User-Define and 999.99	MHz and 100.0000 MHz ed Frequency between 002.0 99 kHz onfiguration code when pin 1	= FS.		
lank>= =	100/Bag 1,000/Ree	I			
×	kkxxx = kx = F lank>=	<pre>k.xxxx = User-Defin 001.0000 kkxxx = User-Defin and 999.9 cx = Frequency cx Configure lank>= 100/Bag</pre>	and 999.999 kHz x = Frequency configuration code when pin 1 Configure the part online through Clock lank>= 100/Bag	 xxxx = User-Defined Frequency between 001.0000 MHz and 100.0000 MHz user-Defined Frequency between 002.000 kHz and 999.999 kHz Frequency configuration code when pin 1 = FS. Configure the part online through ClockWorks lank>= 100/Bag 	 xxxx = User-Defined Frequency between 001.0000 MHz and 100.0000 MHz xxxx = User-Defined Frequency between 002.000 kHz and 999.999 kHz xx = Frequency configuration code when pin 1 = FS. Configure the part online through ClockWorks lank>= 100/Bag

Note 1: Please visit Microchip ClockWorks[®] Configurator Website to configure the part number for customized frequency. http://clockworks.microchip.com/timing/.

DSC61XX

NOTES:

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